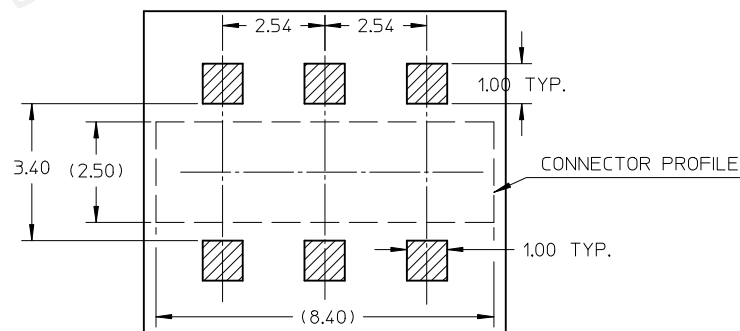
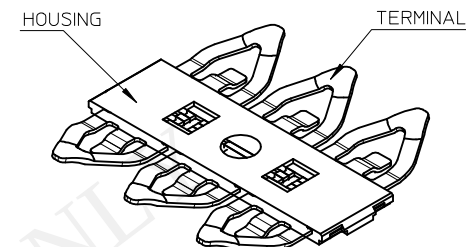
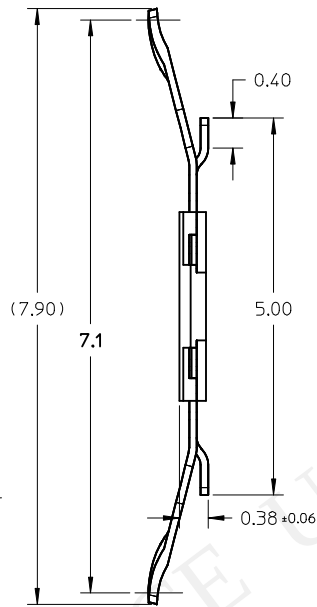
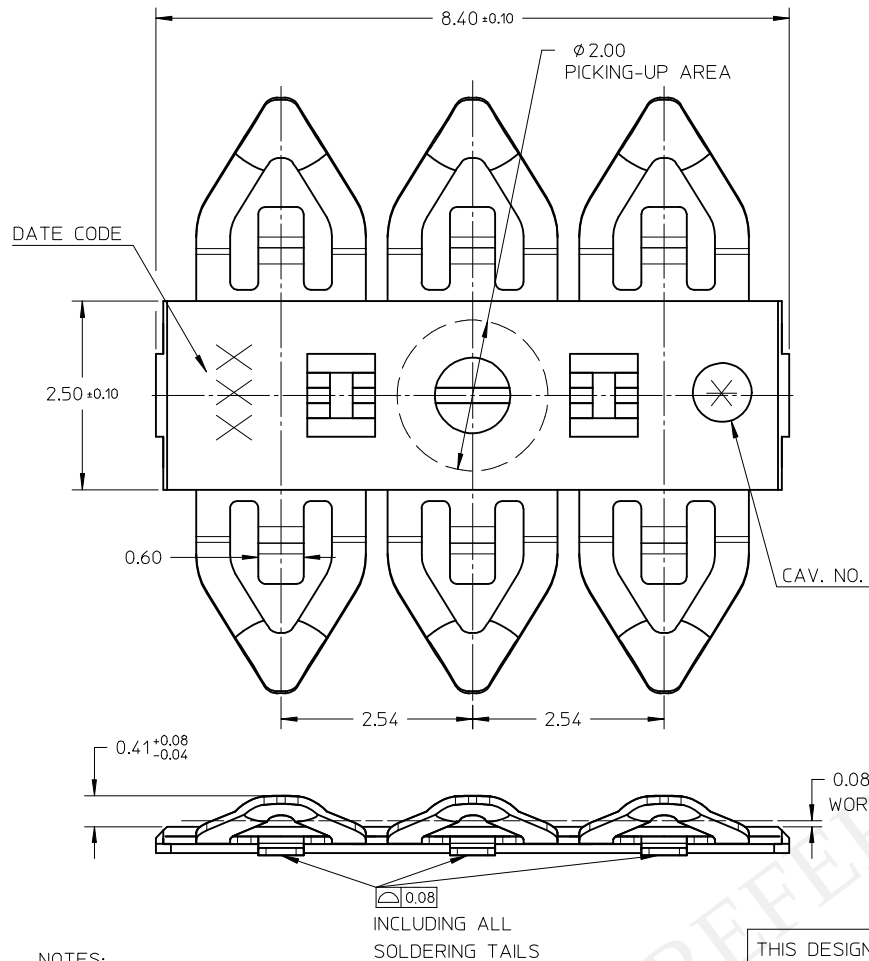




RECOMMENDED PCB LAYOUT
TOLERANCE: ±0.05MM

NOTES:

1. MATERIALS:

HOUSING: LCP, UL94V-0;
TERMINAL: COPPER ALLOY;

2. FINISHES:

TERMINAL:
1.27μM MIN. NICKEL UNDERPLATING OVERALL;
0.38μM MIN. GOLD PLATING ON CONTACT AREA;
0.05μM MIN. GOLD FLASH PLATING ON SOLDERING TAIL AREA;

3. PRODUCT SPECIFICATION: PS-151130-0001;
4. PACKAGING SPECIFICATION: PK-151130-0001;
5. NO CIRCUIT ALLOWED UNDER CONNECTOR;
6. DATE CODE PRINTED: XXX;

DAY OF THE YEAR

THIS DESIGN IS BASED ON DESIGN OBJECTIVES
AND IS STRICTLY TENTATIVE. IT MAY CHANGE
BASED ON RESULTS OF ADDITIONAL DESIGN
REVIEWS & VERIFICATIONS.

DRAWING REVISE
EC NO: S2015-1463
DRWN:HLWANG06
CHKD:JZENG
APPR:HLWANG06

QUALITY
SYMBOLS
F_A=0
F_G=0
F_P=0

GENERAL TOLERANCES
(UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± 0.13	± ---
1 PLACE	± 0.20	± ---
0 PLACE	± ---	± ---

ANGULAR ± 3 °
DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
MM ONLY

DRAWN BY	DATE
HLWANG06	2014/11/25
CHECKED BY	DATE
JZENG	2014/12/22
APPROVED BY	DATE
HLWANG06	2014/12/23

MATERIAL NO.
1511300001

SCALE
NTS

DESIGN UNITS
METRIC

THIRD ANGLE
PROJECTION

TITLE
SALES DRAWING FOR
0.38MM HEIGHT
BLOCK SIM CONNECTOR

DOCUMENT NO.
SD-151130-0001

SHEET NO.
1 OF 1

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX
INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION